

**PATENT**Docket No. JCLA12795  
page 1**IN THE UNITED STATE PATENT AND TRADEMARK OFFICE**

In re application of :

Applicant : CHENG-KUANG SUN et al.  
 Application No. : 10/791,325  
 Filed : March 01, 2004  
 For : CHIP ON PHOTORESISTIVE DEVICE PACKAGE STRUCTURE AND  
       ELECTRICAL CONNECTION THEREOF  
 Examiner : VU, HUNG K.  
 Art Unit : 2811

**TRANSMITTAL SHEET**

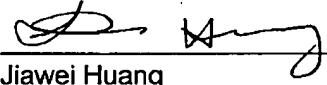
Commissioner for Patents  
 P.O. Box 1450  
 Alexandria, VA 22313-1450

Sir:

The fee has been calculated as shown below:

<b>CLAIMS AS FILED</b>						
<b>CLAIMS REMAINING AFTER AMENDMENT</b>		<b>HIGHEST NO. PREVIOUSLY PAID FOR</b>	<b>PRESENT EXTRA</b>	<b>RATE</b>	<b>ADDITIONAL FEE</b>	
Total Claims	18	MINUS	20	= 0 x	\$ 50	= \$ 0
Independent Claims	4	MINUS	3	= 1 x	\$ 200	= \$ 200
<b>TOTAL: \$ 200</b>						

(X) The commissioner is authorized to charge the required fee in the amount of \$ 200 as calculated above or any other necessary fees in connection with the filing of this paper to Deposit Account No. 50-0710 (Order No. JCLA12795).

Date: 4/29/2005
  
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 Registration No. 43,330
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